

Product / Process Change Notification



N° 2021-058-A

Dear Customer,

Please find attached our Infineon Technologies AG PCN:

Removal of additional label on the module card box

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **18 May 2021**
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:
“**Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Dr. Wolfgang Eder
Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Dr. Sven Schneider
Registered Office: Neubiberg
Commercial Register: München HRB 126492

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► **Products affected:**

Please refer to attached affected product list
“pcn_2021-058-A_[customer-no].pdf”

► **Detailed Change Information:**

Subject: IHM A and IHV B are packed in card boxes. These boxes can have a capacity of one to four modules. After sealing the package with the shipment label, additional labels of the enclosed modules are placed on the box. These labels are going to be removed since the identical information is available on the enclosed modules.

Reason: Simplification and standardization of production process

Description:

Old

Copies of module labels attached to the carton box



New

Module labels removed



► **Product Identification:**

Date code

► **Impact of Change:**

No impact on electrical performance. Quality and reliability verified by qualification. There is no change in form, fit and function
There is no change in the assembly process at Infineon.

► **Attachment:**

Affected product list pcn_2021-058-A_[customer-no].pdf

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► Time Schedule:

- | | |
|-------------------------------|-------------------------------------|
| ■ Final qualification report: | n.a. |
| ■ First samples available: | n.a. |
| ■ Intended start of delivery: | From beginning of July 2021 onwards |

If you have any questions, please do not hesitate to contact your local Sales office.

PCN2021-058-A

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Affected products sold to DIGI-KEY (4002348)

Sales name	SP number	OPN	Package	Customer part number
DD800S33K2C	SP000100612	DD800S33K2CNOSA1	A-IHV130	DD800S33K2CNOSA1
FZ1000R33HE3	SP001181824	FZ1000R33HE3BPSA1	AG-IHVB130	FZ1000R33HE3BPSA1
FZ1400R33HE4	SP005122338	FZ1400R33HE4BPSA1	AG-IHVB130	FZ1400R33HE4
FZ1500R33HE3	SP001181576	FZ1500R33HE3BPSA1	AG-IHVB190	FZ1500R33HE3BPSA1
FZ2000R33HE4	SP003062218	FZ2000R33HE4BOSA1	AG-IHVB190	FZ2000R33HE4BOSA1
FZ2000R33HE4	SP003062218	FZ2000R33HE4BOSA1	AG-IHVB190	FZ2400R33HE4